

SID

Factory: Rot am See

Article:

ML10

Provided:

Customer:

Date:

03.04.2026

WÜRTH
ELEKTRONIK
MORE THAN
YOU EXPECT

Processtechnology: B: undefined

Material Text	Mat. Nr.	µm		Stackup	Process overview
A-RS Kupferfolie-018my 330x490mm	50200238	18	VS	1	B00
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	192		2	
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	0		3	
		18	L2	4	
C-RS-FR4-ML-0.305mm-018+018-TG150-HF-...	50203028	305			
		18	L3		
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	139		5	
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	0		6	
		18	L4	7	
C-RS-FR4-ML-0.305mm-018+018-TG150-HF-...	50203028	305			
		18	L5		
C-RAS-FR4-PP-2116_H50-TG150HF-gel-PAN...	50202536	231		8	
C-RAS-FR4-PP-2116_H50-TG150HF-gel-PAN...	50202536	0		9	
		18	L6	10	
C-RS-FR4-ML-0.305mm-018+018-TG150-HF-...	50203028	305			
		18	L7		
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	139		11	
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	0		12	
		18	L8	13	
C-RS-FR4-ML-0.305mm-018+018-TG150-HF-...	50203028	305			
		18	L9		
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	192		14	
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	0		15	
A-RS Kupferfolie-018my 330x490mm	50200238	18	RS	16	

Thickness after Pressing

B00:

2290 µm

Tol+:

240 µm

Tol-:

240 µm

Dmax:

2530 µm

Dmin:

2050 µm

Thickness over all

0 µm

Tol+:

0 µm

Tol-:

0 µm

Dmax:

0 µm

Dmin:

0 µm

Demand for customer

Thickness (D):

2400 µm

Tol+:

240 µm

Tol-:

240 µm

Dmax:

2640 µm

Dmin:

2160 µm

Measuring point: (05) over SM and galv. Cu; both sides

nominal:

2293 µm

Version 1.2.20.35

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